

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:	)	
	)	
LERNER et al.	)	Group Art Unit: 2823
	)	
Application Number: 10/530,343	)	Examiner: William D. Coleman
	)	
Filed: April 6, 2005	)	Confirmation No.: 7755
	)	
For: TRENCH INSULATION IN SUBSTRATE DISKS COMPRISING LOGIC SEMICONDUCTORS AND POWER SEMICONDUCTORS		

**MAIL STOP ISSUE FEE**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**ISSUE FEE PAYMENT TRANSMITTAL**

In accordance with the Notice of Allowance and Issue Fee Due mailed, applicants are submitting herewith the Issue Fee Transmittal (Part B) in the above-captioned application.

The commissioner is authorized to charge \$1,700 for the filing fee to the undersigned's Deposit Account No. 50-0206 to cover the Issue and Publication Fees for a small entity and advance patent copies fee. In the event any variance exists between the amount enclosed and the Patent Office charges, please charge or credit any difference to the undersigned's Deposit Account No. 50-0206.

Respectfully submitted,

HUNTON & WILLIAMS LLP

Dated: July 19, 2007

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